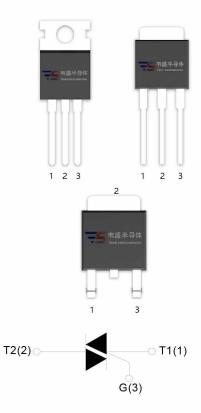


DESCRIPTION:

BT137-SS triacs with low holding and latching current are especially recommended for use on middle and small resistance type power load.



MAIN FEATURES

Symbol Value		Unit
I _{T(RMS)}	8	Α
V _{DRM} /V _{RRM}	600 and 800	V

ABSOLUTE MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
Storage junction temperature range		T _{stg}	-40-150	$^{\circ}$
Operating junction temperature range		Tj	-40-125	$^{\circ}$
Repetitive peak off-sta	te voltage(Tj=25℃)	V _{DRM}	600/800	V
Repetitive peak reverse voltage(Tj=25℃)		V _{RRM}	600/800	V
RMS on-state current	TO-251/ TO-220B(Non-Ins)/ TO-220C(Tc=95℃) TO-262/ TO-220A(Ins)/ TO-220F(Ins) (Tc=85℃)	I _{T(RMS)}	8	А
Non repetitive surge peak on-state current (full cycle, F=50Hz)		Ітѕм	65	Α
I ² t value for fusing (tp=10ms)		l ² t	21	A ² s
Peak gate current		Івм	2	Α



Critical rate of rise of on-state	I - II -III	dI/dt	50	A/µs
current(I _G =2×I _{GT})	IV		10	
Average gate power dissipation	P _{G(AV)}	0.5	W	
Peak gate power	P _{GM}	5	W	

ELECTRICAL CHARACTERISTICS (T_j=25°C unless otherwise specified)

Symbol	Test Condition	Quadrant		Value			Linit	
				D	E	F	G	Unit
l	V _D =12V R _L =30Ω	I - II -III	MAX	5	10	25	50	mA
lgт		IV		10	25	70	100	
V _{GT}		ALL	MAX	1.3				V
V _{GD}	$V_D=V_{DRM}$ $T_j=125$ °C $R_L=3.3$ KΩ	ALL	MIN	0.2			V	
IL	I _G =1.2I _{GT}	I -III	MAX	10	20	50	70	mA
		II - IV		20	30	70	100	
lн	I _T =100mA		MAX	10	15	40	60	mA
dV/dt	V _D =2/3V _{DRM} Gate Open T _j =125℃		MIN	20	50	50	200	V/µs

STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V _{TM}	I _{TM} =10A tp=380μs	Tj=25℃	1.6	V
I _{DRM}	V _D =V _{DRM} V _R =V _{RRM}	Tj=25℃	5	μΑ
I _{RRM}		T _j =125℃	1	mA

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit	
R _{th(j-c)} ju	junction to case(AC)	TO-251	2.1		
		TO-220B(Non-Ins)/ TO-220C	1.8	- AA/	
		TO-220A(Ins)/ TO-220F(Ins)	2.9	· ℃/W	
		TO-262	3.1		

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FIG.1: Maximum power dissipation versus RMS on-state current

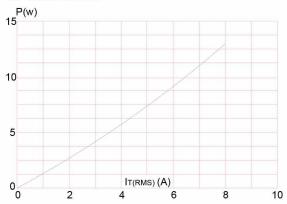


FIG.3: Surge peak on-state current versus number of cycles

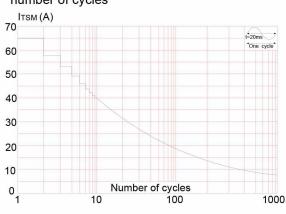


FIG.2: RMS on-state current versus case temperature

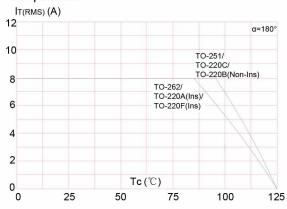


FIG.4: On-state characteristics (maximum values)

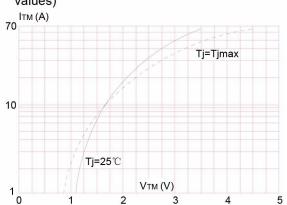




FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<20ms, and corresponging value of I^2t (I - II -III:dI/dt < 50A/ μ s; IV:dI/dt < 10A/ μ s)

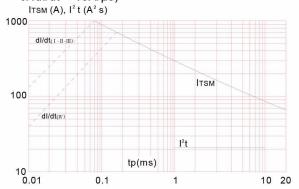


FIG.7: Relative variations of holding current versus junction temperature

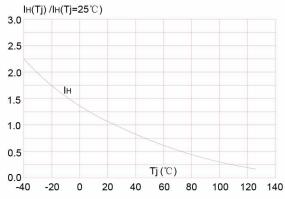


FIG.6: Relative variations of gate trigger current versus junction temperature

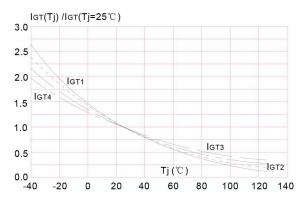


FIG.8: Relative variations of latching current versus junction temperature

